

DATA SHEET

SKY65045-70LF: 390 – 1500 MHz Low Noise Power Amplifier Driver

Applications

- UHF television
- TETRA radio
- GSM, AMPS, PCS, DCS, 2.5G, 3G
- ISM band transmitters
- Fixed WCS
- 802.16 WiMAX
- 3GPP Long Term Evolution

Features

- Wideband frequency range: 390 to 1500 MHz
- Low Noise Figure: 1.8 dB
- High linearity OIP3: +37.5 dBm
- 0P1dB = +25 dBm
- High gain: 14 dB
- Single DC supply: +5 V
- On-chip bias circuit
- SOT-89 (4-pin 2.4 x 4.5 mm) Pb-free package (MSL1, 260 °C per JEDEC J-STD-0-20)

Skyworks Pb-free products are compliant with all applicable legislation. For additional information, refer to *Skyworks Definition of Lead (Pb)-Free*, document number SQ04-0073.

Description

Skyworks SKY65045-70LF is a high performance, ultra-wideband Power Amplifier (PA) driver with superior output power, low noise, linearity, and efficiency. The device provides a 1.6 dB Noise Figure (NF) and an output power at 1 dB compression of +25 dBm, making the SKY65045-70LF ideal for use in the driver stage of infrastucture transmit chains.

The SKY65045-70LF is fabricated with Skyworks high reliability Heterojunction Bipolar Transistor (HBT) process. The device uses low-cost Surface-Mount Technology (SMT) in the form of a 2.4 x 4.5 mm Small Outline Transistor (SOT-89) package. The module can operate over a temperature range of -40 °C to +85 °C. A populated Evaluation Board is available upon request.

The device package and pinout are shown in Figure 1. A functional block diagram is provided in Figure 2.

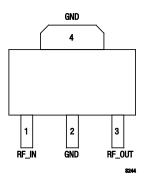


Figure 1. SKY65045-70LF Pinout – 4-Pin SOT-89 Package (Top View)

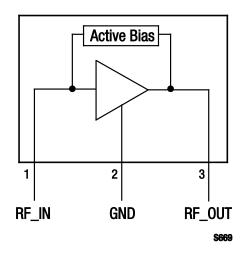


Figure 2. SKY65045-70LF Block Diagram

Technical Description

The SKY65045-70LF is a single stage, low noise PA in a low-cost surface mount package. The device operates with a single +5 V power supply connected though an RF choke (L1) to the output pin. Capacitors C7, C8, and C9 provide DC bias decoupling for VCC.

The bias current is set by the on-chip active bias composed of current mirror and reference voltage transistors, allowing for excellent gain tracking over temperature and voltage variations. The part is externally RF matched using surface mount components to facilitate operation over a frequency range of 390 MHz to 1500 MHz.

Pin 1 is the RF input and pin 3 is the RF output. External DC blocking is required for both input and output, but can be implemented as part of the RF matching circuit. Pin 2 and the package backside metal, pin 4, provide the DC and RF ground.

Electrical and Mechanical Specifications

Signal pin assignments and functional pin descriptions for the SKY65045 are provided in Table 1. The absolute maximum ratings are provided in Table 2, and the recommended operating conditions in Table 3. Electrical characteristics for the SKY65045 are provided in Table 4.

Typical performance characteristics of the SKY65045 are illustrated in Figures 3 through 61 and in Tables 5 through 10. The board layout footprint for the SKY65045-70LF is shown in Figure 66. Package dimensions for the 4-pin SOT-89 are shown in Figure 67, and tape and reel dimensions are shown in Figure 68.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY65045 is rated to Moisture Sensitivity Level 1 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format. For packaging details, refer to the Skyworks Application Note, *Tape and Reel*, document number 101568.

Electrostatic Discharge (ESD) Sensitivity

The SKY65045 is a static-sensitive electronic device. Do not operate or store near strong electrostatic fields. Take proper ESD precautions.

| Pin # | Name | Description |
|-------|--------|-------------|
| 1 | RF_IN | RF input |
| 2 | GND | Ground |
| 3 | RF_OUT | RF output |
| 4 | GND | Ground |

Table 1. SKY65045 Signal Descriptions

Table 2. SKY65045 Absolute Maximum Ratings (Ta = +25 $^{\circ}$ C, Unless Otherwise Noted)

| Parameter | Symbol | Min | Typical | Мах | Units |
|----------------------------|--------|-----|---------|------|-------|
| RF output power | Роит | | +27 | | dBm |
| Supply voltage | VCC | | 6 | | V |
| Supply current | lcc | | 215 | | mA |
| Power dissipation | Po | | 1.3 | | W |
| Operating case temperature | Tc | -40 | | +85 | °C |
| Storage temperature | Tst | -55 | | +125 | °C |
| Junction temperature | TJ | | | 150 | °C |

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal values.

Table 3. SKY65045 Recommended Operating Conditions

| Parameter | Symbol | Min | Typical | Мах | Units |
|----------------------------|--------|-----|---------|------|-------|
| Supply voltage | VCC | | 5 | 5.5 | V |
| Frequency range | f | 390 | | 1500 | MHz |
| Operating case temperature | Tc | -40 | +25 | +85 | °C |

Table 4. SKY65045 Electrical Characteristics (1 of 2) (Note 1)

(VCC = 5.0 V, Output Impedance = 50 Ω , Tc = 25 °C, Unless Otherwise Noted)

| Parameter | Symbol | Test Conditions | Min | Typical | Max | Units |
|---------------------------------|----------|---|-----|---------|-----|-------|
| Test Frequency = 747 MHz | | | | | | |
| Frequency | f | | 697 | 747 | 797 | MHz |
| Small signal gain | G | $P_{IN} = -15 \text{ dBm}$ | | 15 | | dB |
| Input return loss | S11 | Pıℕ = −15 dBm | | 9 | | dB |
| Output return loss | \$22 | $P_{IN} = -15 \text{ dBm}$ | | 8 | | dB |
| Reverse transmission loss | \$12 | Pıℕ = −15 dBm | | 23 | | dB |
| Output power @ 1 dB compression | Р1рв | CW | | +24 | | dBm |
| Operating current | Icc | Роит = +17 dBm | | 70 | | mA |
| Operating current | ICC_P1DB | @ P1dB | | 132 | | mA |
| Power-added efficiency | PAE | @ P1dB | | 35 | | % |
| Input 3rd Order Intercept Point | IIP3 | P_{IN} /tone = -10 dBm, $\Delta F = 1 \text{ MHz}$ | | +29 | | dBm |

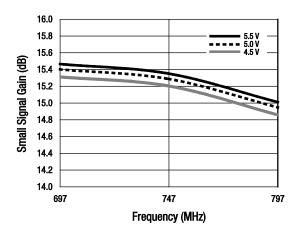
| Parameter | Symbol | Test Conditions | Min | Typical | Max | Units |
|--------------------------------------|----------|--|-------|---------|-------|-------|
| Test Frequency = 747 MHz (continued) |) | | · | | | |
| Output 3rd Order Intercept Point | 0IP3 | Pout/tone = +8 dBm, $\Delta F = 1 \text{ MHz}$ | | +44 | | dBm |
| Noise Figure | NF | Small signal | | 1.9 | | dB |
| Quiescent current | Icco | No RF | | 47 | | mA |
| Test Frequency = 897.5 MHz | | | | | | |
| Frequency | f | | 880.0 | 897.5 | 915.0 | MHz |
| Small signal gain | G | Pıℕ = −15 dBm | 13 | 14 | 16 | dB |
| Input return loss | S11 | $P_{IN} = -15 \text{ dBm}$ | | 12.2 | 10.0 | dB |
| Output return loss | S22 | Pıℕ = −15 dBm | | 19.5 | 10.0 | dB |
| Reverse transmission loss | S12 | Pıℕ = −15 dBm | | 21 | 15 | dB |
| Output power @ 1 dB compression | Р1ов | CW | +22.5 | +25.0 | | dBm |
| Operating current | Icc | Pout = +17 dBm | | 61 | 90 | mA |
| Operating current | Ісс_р1db | @ P1dB | | 133 | 180 | mA |
| Power-added efficiency | PAE | @ P1dB | | 45 | | % |
| Output 3rd Order Intercept Point | 0IP3 | Pout/tone = +17 dBm, $\Delta F = 1 \text{ MHz}$ | +36.0 | +37.5 | | dBm |
| Noise Figure | NF | Small signal | | 1.8 | 2.4 | dB |
| Quiescent current | la | No RF | | 46 | 60 | mA |

Table 4. SKY65045 Electrical Characteristics (2 of 2) (Note 1) (VCC = 5.0 V, Output Impedance = 50 Ω , Tc = 25 °C, Unless Otherwise Noted)

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Typical Performance Data

(VCC = 5 V, f = 747 MHz, CW, Output Impedance = 50 Ω , Tc = 25 °C, Unless Otherwise Noted)





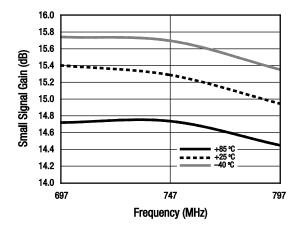


Figure 4. Small Signal Gain vs Frequency Over Temperature

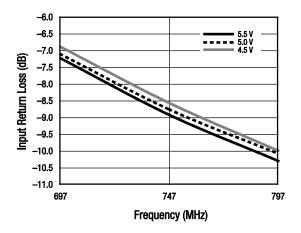


Figure 5. Input Return Loss vs Frequency Over VCC

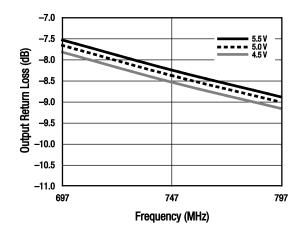


Figure 7. Output Return Loss vs Frequency Over VCC

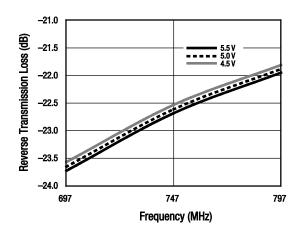


Figure 9. Reverse Transmission Loss vs Frequency Over VCC

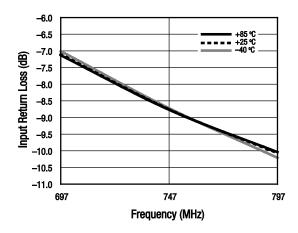


Figure 6. Input Return Loss vs Frequency Over Temperature

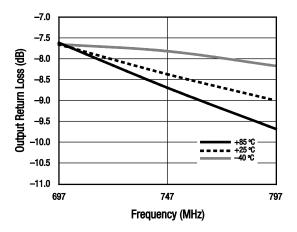


Figure 8. Output Return Loss vs Frequency Over Temperature

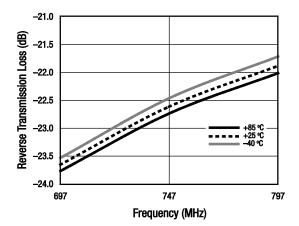


Figure 10. Reverse Transmission Loss vs Frequency Over Temperature

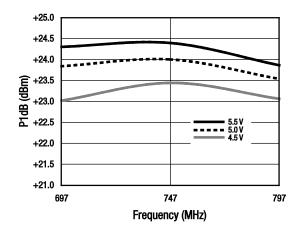


Figure 11. P1dB vs Frequency Over VCC

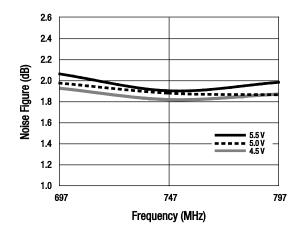


Figure 13. Noise Figure vs Frequency Over VCC

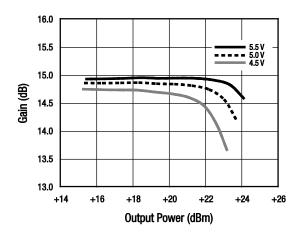


Figure 15. Gain vs Output Power Over VCC

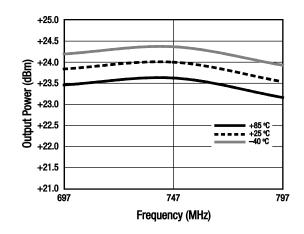


Figure 12. P1dB vs Frequency Over Temperature

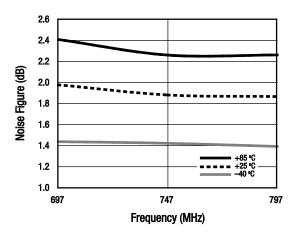


Figure 14. Noise Figure vs Frequency Over Temperature

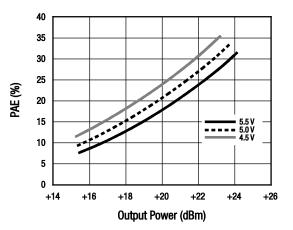


Figure 16. PAE vs Output Power Over VCC

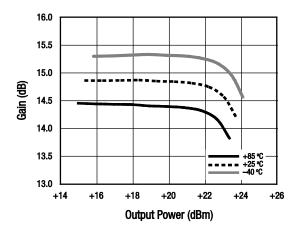


Figure 17. Gain vs Output Power Over Temperature

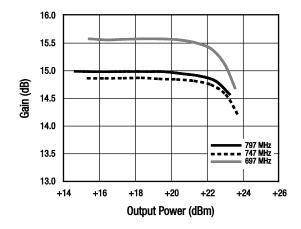


Figure 19. Gain vs Output Power Over Frequency

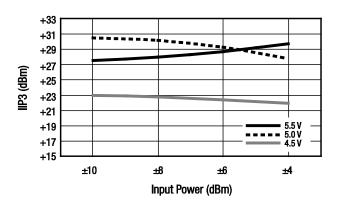


Figure 21. IIP3 vs Input Power Over VCC

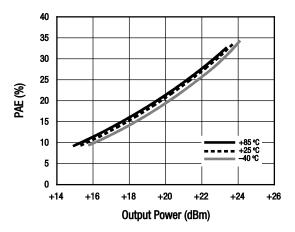


Figure 18. PAE vs Output Power Over Temperature

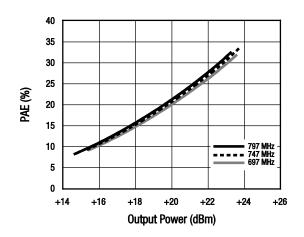


Figure 20. PAE vs Output Power Over Frequency

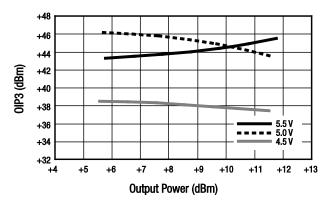


Figure 22. OIP3 vs Output Power Over VCC

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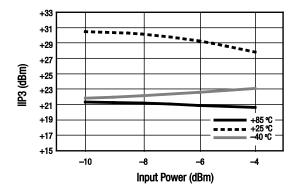


Figure 23. IIP3 vs Input Power Over Temperature

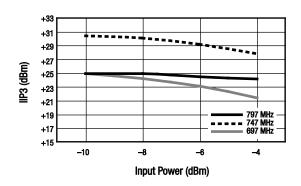
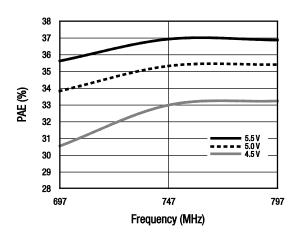


Figure 25. IIP3 vs Input Power Over Frequency





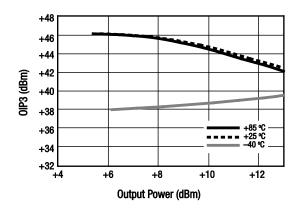
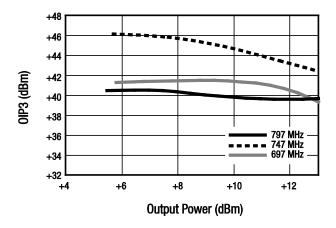


Figure 24. OIP3 vs Output Power Over Temperature





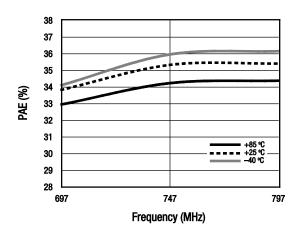


Figure 28. PAE @ P1dB vs Frequency Over Temperature

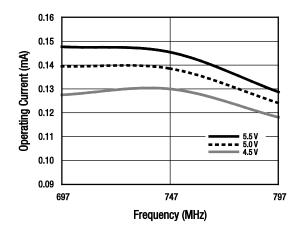


Figure 29. Operating Current @ P1dB vs Frequency Over VCC

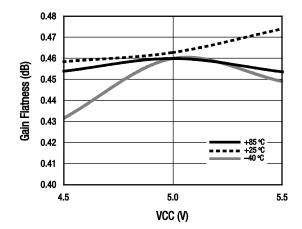


Figure 31. Gain Flatness vs VCC Over Temperature

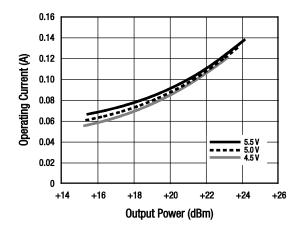


Figure 33. Operating Current vs Output Power Over VCC

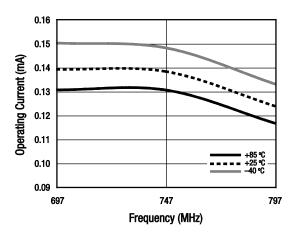


Figure 30. Operating Current @ P1dB vs Frequency Over Temperature

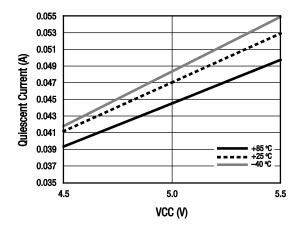


Figure 32. Quiescent Current vs VCC Over Temperature

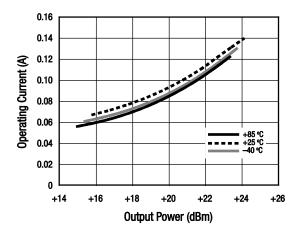


Figure 34. Operating Current vs Output Power Over Temperature

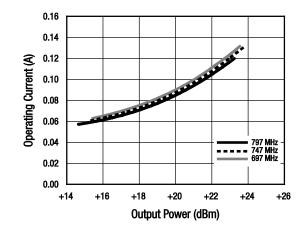


Figure 35. Operating Current vs Output Power Over Frequency

Typical Performance Data (VCC = 5 V, f = 897.5 MHz, CW, Output Impedance = 50 Ω , Tc = 25 °C, Unless Otherwise Noted)

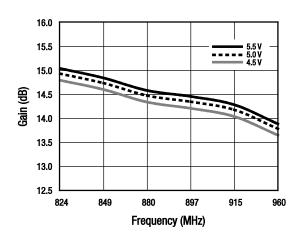


Figure 36. Small Signal Gain vs Frequency Over VCC

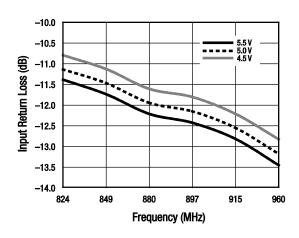


Figure 38. Input Return Loss vs Frequency Over VCC

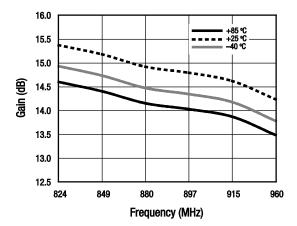


Figure 37. Small Signal Gain vs Frequency Over Temperature

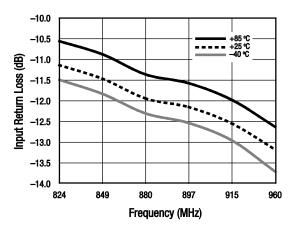


Figure 39. Input Return Loss vs Frequency Over Temperature

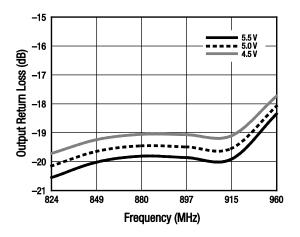


Figure 40. Output Return Loss vs Frequency Over VCC

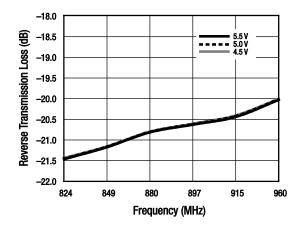


Figure 42. Reverse Transmission Loss vs Frequency Over VCC

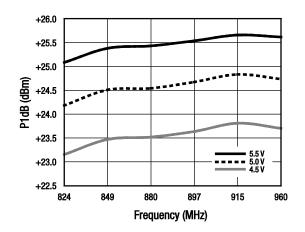


Figure 44. P1dB vs Frequency Over VCC

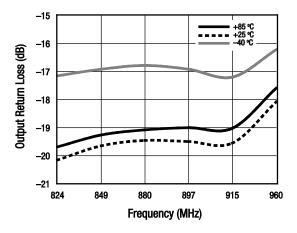


Figure 41. Output Return Loss vs Frequency Over Temperature

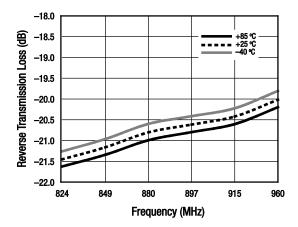


Figure 43. Reverse Transmission Loss vs Frequency Over Temperature

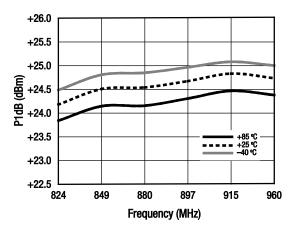


Figure 45. P1dB vs Frequency Over Temperature

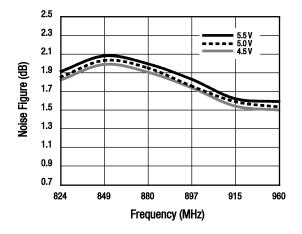


Figure 46. Noise Figure vs Frequency Over VCC

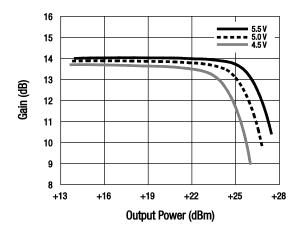


Figure 48. Gain vs Output Power Over VCC

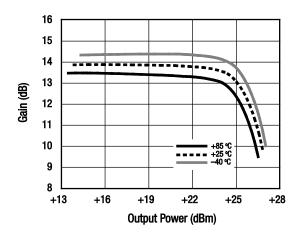


Figure 50. Gain vs Output Power Over Temperature

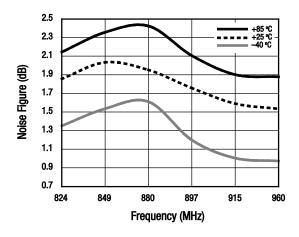


Figure 47. Noise Figure vs Frequency Over Temperature

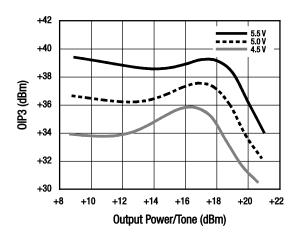


Figure 49. OIP3 vs Output Power/Tone Over VCC

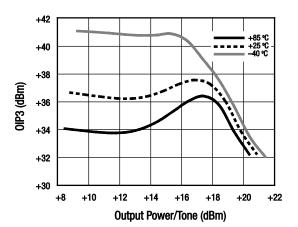


Figure 51. OIP3 vs Output Power/Tone Over Temperature

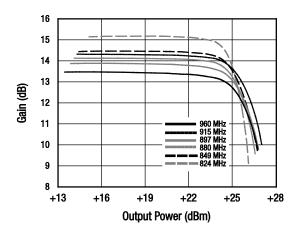


Figure 52. Gain vs Output Power Over Frequency

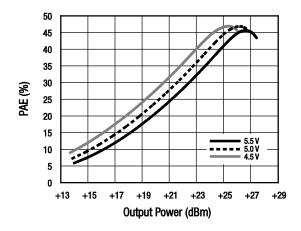


Figure 54. PAE vs Output Power Over VCC

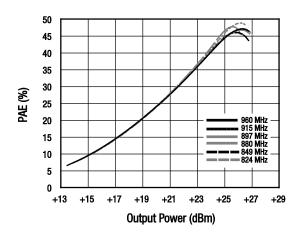


Figure 56. PAE vs Output Power Over Frequency

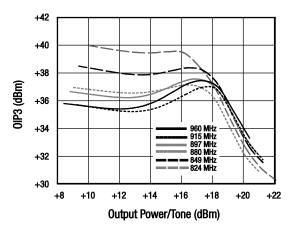


Figure 53. OIP3 vs Output Power/Tone Over Frequency

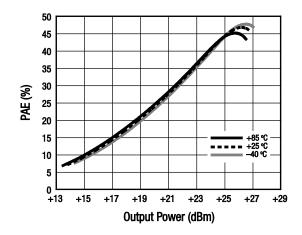


Figure 55. PAE vs Output Power Over Temperature

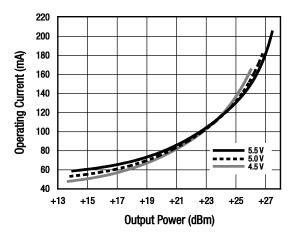


Figure 57. Operating Current vs Output Power Over VCC

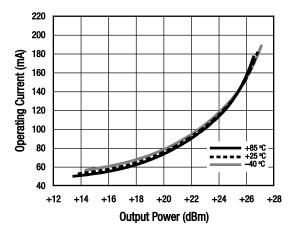


Figure 58. Operating Current vs Output Power Over Temperature

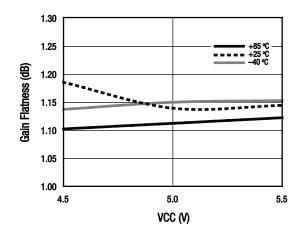


Figure 60. Gain Flatness vs VCC Over Temperature

| Table 5. PAE Performance @ P1dB vs Output Power Over VC | Table 5. | PAE Perfor | mance @ P | 1dB vs 0 | utput Powe | r Over VCC |
|---|----------|------------|-----------|----------|------------|------------|
|---|----------|------------|-----------|----------|------------|------------|

| VCC (V) | PAE @ P1dB (%) | Pout (dBm) |
|---------|----------------|------------|
| 4.5 | 43.9 | +23.9 |
| 5.0 | 44.8 | +25.1 |
| 5.5 | 45.0 | +26.1 |

Table 6. PAE Performance @ P1dB vs Output Power Over Temperature

| Temperature (°C) | PAE @ P1dB (%) | Роит (dBm) |
|------------------|----------------|------------|
| -40 | 45.8 | +25.38 |
| +25 | 44.5 | +25.04 |
| +85 | 43.3 | +24.65 |

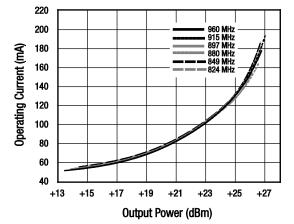


Figure 59. Operating Current vs Output Power Over Frequency

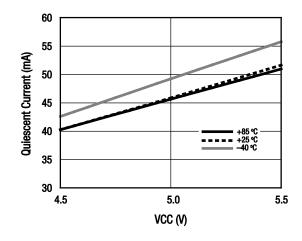


Figure 61. Quiescent Current vs VCC Over Temperature

| Frequency (MHz) | PAE @ P1dB (%) | Pout (dBm) |
|-----------------|----------------|------------|
| 824 | 46.3 | +24.92 |
| 849 | 45.5 | +25.24 |
| 880 | 46.5 | +25.13 |
| 897 | 44.7 | +25.04 |
| 915 | 45.8 | +25.35 |
| 960 | 45.8 | +25.38 |

Table 7. PAE Performance @ P1dB vs Output Power Over Frequency

Table 8. Supply Current Performance @ P1dB vs Output Power Over VCC

| VCC (V) | Operating Current (mA) | Роит (dBm) |
|---------|------------------------|------------|
| 4.5 | 117 | +23.9 |
| 5.0 | 133 | +25.1 |
| 5.5 | 152 | +26.1 |

Table 9. Supply Current Performance @ P1dB vs Output Power Over Temperature

| Temperature (°C) | Operating Current (mA) | Роит (dBm) |
|------------------|------------------------|------------|
| -40 | 142 | +25.42 |
| +25 | 133 | +25.05 |
| +85 | 125 | +24.65 |

Table 10. Supply Current Performance @ P1dB vs Output Power Over Frequency

| | • • • | |
|-----------------|------------------------|------------|
| Frequency (MHz) | Operating Current (mA) | Роит (dBm) |
| 824 | 126 | +24.92 |
| 849 | 137 | +25.26 |
| 880 | 130 | +25.14 |
| 897 | 133 | +25.06 |
| 915 | 139 | +25.34 |
| 960 | 138 | +25.38 |

Evaluation Board Description

The Skyworks SKY65045 Evaluation Board is used to test the performance of the SKY65045-70LF PA driver. The Evaluation Board schematic diagram is shown in Figure 62. An assembly drawing for the Evaluation Board is shown in Figure 63 and the layer detail is provided in Figure 64. The layer detail physical characteristics are noted in Figure 65. Tables 11 and 12 (747 MHz and 897.5 MHz, respectively) provide the Bill of Materials (BOM) list for Evaluation Board components.

Circuit Design Configurations

The following design considerations are general in nature and must be followed regardless of final use or configuration:

- 1. Paths to ground should be made as short as possible.
- 2. The ground pad of the SKY65045-70LF has special electrical and thermal grounding requirements. This pad is the main thermal conduit for heat dissipation. Since the circuit board acts as the heat sink, it must shunt as much heat as possible from the device. Therefore, design the connection to the ground pad to dissipate the maximum wattage produced by the circuit board. Multiple vias to the grounding layer are required.

- Skyworks recommends including external bypass capacitors on the DC supply lines. An RF inductor is required on the VCC supply line to block RF signals from the DC supply. Refer to Figure 62 for more detail.
- 4. The RF lines should be well separated from each other with solid ground in between traces to maximize input-to-output isolation.
- **NOTE:** Junction temperature (T_J) of the device increases with a poor connection to the slug and ground. This reduces the lifetime of the device.

Application Circuit Notes

RF_IN (pin 1): The amplifier requires a DC blocking capacitor as part of the external RF matching.

GND (pin 2): Attach the ground pin to the RF ground plane with the largest diameter and lowest inductance via that the layout allows. Multiple small vias are also acceptable and will work well under the device if solder migration is an issue.

RF_OUT (pin 3): The amplifier requires a DC blocking capacitor as part of the external RF matching. The amplifier collector supply voltage is supplied through an RF choke to the output at pin 3.

GND (pin 4): It is extremely important that the device paddle be sufficiently grounded for both thermal and stability reasons. Multiple small vias are acceptable and will work well under the device if solder migration is an issue.

Testing Procedure

Use the following procedure to set up the SKY65045 Evaluation Board for testing:

- 1. Connect a 5 V supply to VCC. If available, enable the current limiting function of the power supply to 100 mA.
- Connect a signal generator to the RF signal input port. Set it to the desired RF frequency at a power level of -15 dBm or less to the Evaluation Board but do NOT enable the RF signal.
- 3. Connect a spectrum analyzer to the RF signal output port.
- 4. Enable the power supply.
- 5. Enable the RF signal.
- 6. Take measurements.

CAUTION: If any of the output signals exceed the rated maximum values, the SKY65045 Evaluation Board can be permanently damaged.

NOTE: It is important to adjust the VCC voltage source so that +5 V is measured at the board. The high collector currents drop the collector voltage significantly if long leads are used. Adjust the bias voltage to compensate.

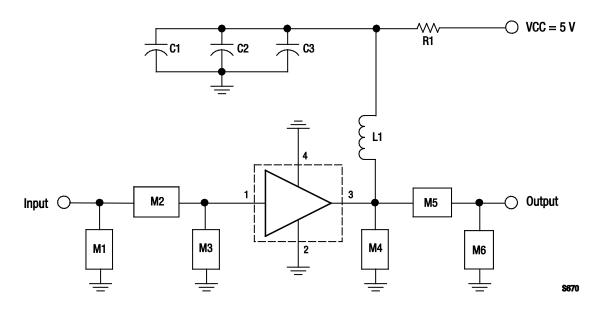


Figure 62. SKY65045 Evaluation Board Assembly Drawing (Refer to Tables 11 and 12 for Component Values)

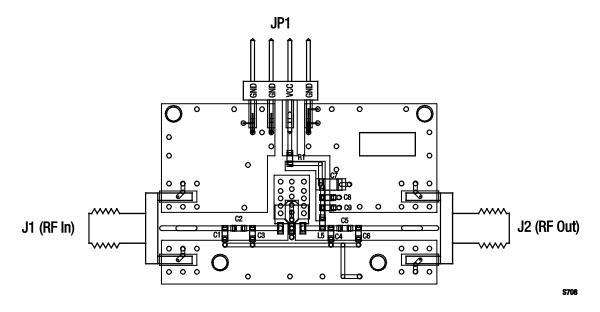


Figure 63. SKY65045 Evaluation Board Assembly Drawing

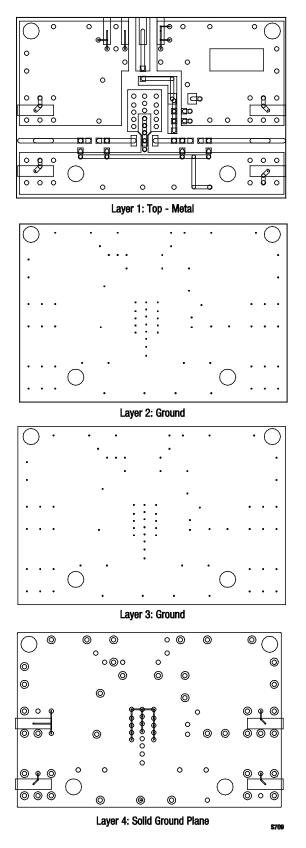


Figure 64. Evaluation Board Layer Detail

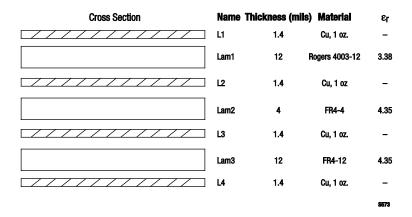


Figure 65. Layer Detail Physical Characteristics

Table 11. SKY65045 Evaluation Board Bill of Materials (747 MHz)

| Component | Quantity | Value | Size | Product Number | Manufacturer | Manufacturer's Part Number | Characteristics |
|-----------|----------|--------|------|-------------------|--------------|-------------------------------|-----------------------|
| R1 | 1 | 0 Ω | 0603 | 5424R20-146 | Rohm | MCR03EZHJ000 | 50 V, 0.063 Ω, ±5% |
| C7 | 1 | 10 µF | 0805 | 5404R29-076 | Murata | GRM21BR60J106K | X5R, 50 V, ±20% |
| C8 | 1 | 12 pF | 0603 | 5404R23-014 | Murata | GRM1885C1H120JD51D | COG, 50 V, ±5% |
| C9 | - | DNI | - | - | - | - | - |
| L5 | 1 | 3.3 nH | 0603 | 5332R34-005 | Taiyo-Yuden | HK16083N3S-T | ±0.3 nH, SRF 6000 MHz |
| M1 | 1 | 10 nH | 0603 | 5332R34-020 | Taiyo-Yuden | HK160810NJ-T | ±5%, SRF 3400 MHz |
| M2 | 1 | 4.7 pF | 0603 | 5404R98-006 | Murata | GRM1885C1H4R7CZ01D | COG, 50 V, ± 0.25 pF |
| M3 | - | DNI | - | - | - | - | - |
| M4 | - | DNI | - | - | - | - | - |
| M5 | 1 | 4.3 pF | 0603 | 5404R71-022 | Murata | - | COG, 50 V, ±0.25 pF |
| M6 | 1 | 6.8 nH | 0603 | 5332R34-020 | Taiyo-Yuden | _ | ±5%, SRF 3400 MHz |

Table 12. SKY65045 Evaluation Board Bill of Materials (897.5 MHz)

| Component | Quantity | Value | Size | Product Number | Manufacturer | Manufacturer's Part Number | Characteristics |
|-----------|----------|---------|------|-------------------|--------------|-------------------------------|----------------------|
| R1 | 1 | 0 Ω | 0603 | 5424R20-146 | Rohm | MCR03EZHJ000 | 50 V, 0.063 Ω, ±5% |
| C7 | 1 | 1 μF | 0805 | 5404R29-070 | TDK | C2012X7R1H104K | X7R, 50 V, ±10% |
| C8 | 1 | 1000 pF | 0603 | 5404R23-057 | TDK | C1608C0G1H102JT | COG, 50 V, ±5% |
| C9 | - | DNI | - | - | - | - | - |
| L5 | 1 | 39 nH | 0603 | 5332R34-034 | Taiyo-Yuden | HK160839NJ-T | ±5%, SRF 1100 MHz |
| M1 | 1 | DNI | - | - | - | - | - |
| M2 | 1 | 10 pF | 0603 | 5404R23-013 | Murata | GRM39COG100J050AD | COG, 50 V, ± 5% |
| M3 | 1 | 2.2 pF | 0603 | 5404R23-039 | Murata | GRM1885C1H2R2CZ01D | COG, 50 V, ± 0.25 pF |
| M4 | - | DNI | - | - | - | - | - |
| M5 | 1 | 15 pF | 0603 | 5404R23-015 | Murata | GRM1885C1H150JD51D | COG, 50 V, ±5% |
| M6 | _ | DNI | - | - | _ | _ | - |

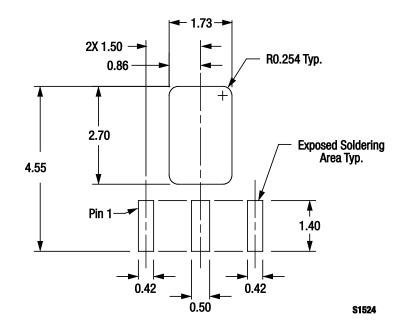
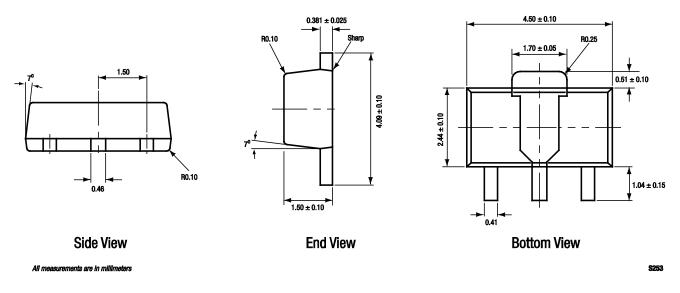


Figure 66. SKY65045-70LF Board Layout Footprint





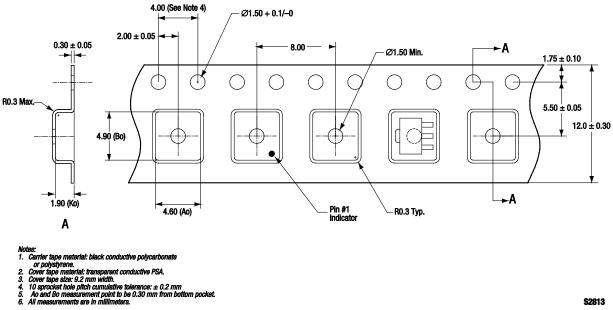


Figure 68. SKY65045 SOT-89 Tape and Reel Dimensions

Ordering Information

| Model Name | Ordering Part Number | Evaluation Board Part Number | |
|--|----------------------|------------------------------|--|
| SKY65045-70LF 390-1500 MHz Low Noise PA Driver | SKY65045-70LF | TW17-D630-001 (747 MHz) | |
| | | TW17-D440-001 (897.5 MHz) | |

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